

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20180611003 Datasheet for LMT01 Information Only

Date: June 14, 2018 To: PREMIER FARNELL PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (<u>PCN ww admin team@list.ti.com</u>).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE

LMT01LPG

CUSTOMER PART NUMBER null

Technical details of this Product Change follow on the next page(s).

PCN Number: 20180611003			PCN Date: June 14, 2018				
Title: Datasheet for LMT01							
Customer Contact:	PCN Manager	Manager			ept:	Quality Services	
Change Type:						· · ·	
Assembly Site		Design			Wafer	· Bump Site	
Assembly Process					Wafer	· Bump Material	
Assembly Materials		Part number change			Wafer Bump Process		
Mechanical Specific	cation	Test Site			Wafer	· Fab Site	
Packing/Shipping/L	abeling	Test Process			Wafer	· Fab Materials	
					Wafer	Fab Process	
Notification Details							
Description of Change:							
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.							
SNIS189D – JUNE 2015 – REVISED JUNE 2018							
Changes from Revision C (June 2017) to Revision D Page							
Added device stamp to the TO 00 pipeut ten view							
Added device stamp to the TO-92 pinout top view							
Changed the TO-92S pin numbers in the Pin Functions							
The detected number will be changing							
The datasheet number will be changing. Device Family			Change From:		Change To:		
			, j		SNIS189D		
LMT01			SNIS189C SI			.89D	
These changes may be reviewed at the datasheet links provided.							
http://www.ti.com/product/LMT01							
Reason for Change:							
To accurately reflect device characteristics.							
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):							
No anticipated impact. This is a specification change announcement only. There are no changes							
to the actual device.	•		5			5	
Changes to product identification resulting from this PCN:							
None.							
Product Affected:							
		т				MT01LDCM	
LMT01DQXR	LMT01DQX		LMT01LPG		<u> </u>	MT01LPGM	
For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.							

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com